



## Hybrid and Polymer Assemblies

Guest Editors:

**Dr. Anna Vikulina**

Department of Chemistry and Forensics, School of Science and Technology, Nottingham Trent University, Clifton Lane, Nottingham NG11 8NS, UK

**Prof. Dr. Dmitry Volodkin**

College of Science and Technology, Nottingham Trent University, Clifton Lane, Nottingham NG11 8NS, UK

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### Message from the Guest Editors

Polymer self-assembly has become extremely attractive for both biological (drug delivery, tissue engineering, scaffolds) and nonbiological (packaging, semiconductors) applications. In nature, a number of key biological processes are driven by polymer self-assembly, for instance, protein folding. Impressive morphologies can be assembled from polymers thanks to a diverse range of interactions involved, e.g., electrostatics, hydrophobic, host-guest interactions. Both 2D and 3D tailor-made assemblies can be designed through modern powerful techniques and approaches such as the layer-by-layer and the Langmuir-Blodgett deposition, hard and soft templating.

This Special Issue highlights contributions (research papers, short communications, and review articles) that focus on recent developments in polymer self-assembly for fundamentally understanding both the assembly phenomenon and real applications





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## Editor-in-Chief

### Prof. Dr. Ai-Qun Liu

1. Department of Electrical and Electronic Engineering, The Hong Kong Polytechnic University, Hong Kong, China  
2. School of Electrical and Electronic Engineering, Nanyang Technological University, Singapore 639798, Singapore

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*Micromachines* Editorial Office  
MDPI, Grosspeteranlage 5  
4052 Basel, Switzerland

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